

## N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTOR

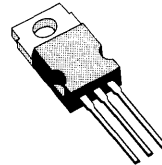
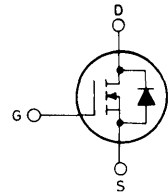
TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
BUZ20	100 V	0.2 Ω	12 A

- 100 VOLTS - FOR UPS APPLICATIONS
- ULTRA FAST SWITCHING
- RATED FOR UNCLAMPED INDUCTIVE SWITCHING (ENERGY TEST) ♦
- EASY DRIVE - FOR REDUCED AND COST

**INDUSTRIAL APPLICATIONS:**

- UNINTERRUPTIBLE POWER SUPPLIES
- MOTOR CONTROLS

N - channel enhancement mode POWER MOS field effect transistor. Easy drive and very fast switching times make this POWER MOS transistor ideal for high speed switching applications. Typical applications include UPS, battery chargers, printer hammer drivers, solenoid drivers and motor control.


**TO-220**
**INTERNAL SCHEMATIC  
DIAGRAM**

**ABSOLUTE MAXIMUM RATINGS**

V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	100	V
V <sub>DGR</sub>	Drain-gate voltage (R <sub>GS</sub> = 20 KΩ)	100	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub>	Drain current (continuous) T <sub>c</sub> = 25°C	12	A
I <sub>DM</sub>	Drain current (pulsed)	48	A
P <sub>tot</sub>	Total dissipation at T <sub>c</sub> < 25°C	75	W
T <sub>stg</sub>	Storage temperature	-55 to 150	°C
T <sub>j</sub>	Max. operating junction temperature	150	°C
	DIN humidity category (DIN 40040)	E	
	IEC climatic category (DIN IEC 68-1)	55/150/56	

♦ Introduced in 1988 week 44

## THERMAL DATA

$R_{thj - case}$	Thermal resistance junction-case	max	1.67	°C/W
$R_{thj - amb}$	Thermal resistance junction-ambient	max	75	°C/W

ELECTRICAL CHARACTERISTICS ( $T_j = 25^\circ\text{C}$  unless otherwise specified)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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## OFF

$V_{(BR) DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu\text{A}$	$V_{GS} = 0$	100		V
$I_{DSS}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating}$	$T_j = 125^\circ\text{C}$			250 $\mu\text{A}$ 1000 $\mu\text{A}$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20 \text{ V}$				$\pm 100 \text{ nA}$

## ON

$V_{GS (th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$	$I_D = 1 \text{ mA}$	2.1		4 V
$R_{DS (on)}$	Static drain-source on resistance	$V_{GS} = 10 \text{ V}$	$I_D = 6 \text{ A}$			0.2 $\Omega$

## ENERGY TEST

$I_{UIS}$	Unclamped inductive switching current (single pulse)	$V_{DD} = 30 \text{ V}$ starting $T_j = 25^\circ\text{C}$	$L = 100 \mu\text{H}$	12		A
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## DYNAMIC

$g_{fs}$	Forward transconductance	$V_{DS} = 25 \text{ V}$	$I_D = 6 \text{ A}$	2.7		mho
$C_{iss}$	Input capacitance	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0$	$f = 1 \text{ MHz}$			2000 pF
$C_{oss}$	Output capacitance					500 pF
$C_{rss}$	Reverse transfer capacitance					140 pF

## SWITCHING

$t_{d (on)}$	Turn-on time	$V_{DD} = 30 \text{ V}$	$I_D = 2.9 \text{ A}$			45 ns
$t_r$	Rise time	$R_{GS} = 50 \Omega$	$V_{GS} = 10 \text{ V}$			75 ns
$t_{d (off)}$	Turn-off delay time					140 ns
$t_f$	Fall time					80 ns

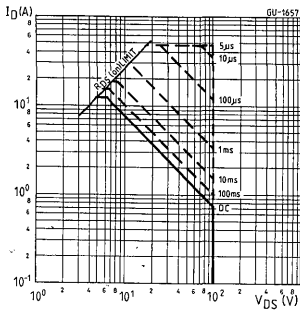
ELECTRICAL CHARACTERISTICS (Continued)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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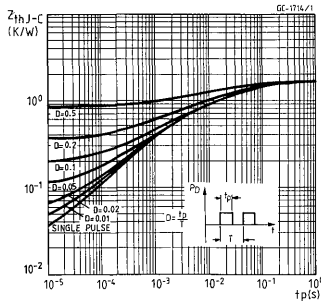
SOURCE DRAIN DIODE

$I_{SD}$ $I_{SDM}$	Source-drain current Source-drain current (pulsed)	$T_c = 25^\circ\text{C}$		12 48	A A
$V_{SD}$	Forward on voltage	$I_{SD} = 24\text{ A}$	$V_{GS} = 0$	1.8	V
$t_{rr}$ $Q_{rr}$	Reverse recovery time Reverse recovered charge	$I_{SD} = 12\text{ A}$	$di/dt = 100\text{A}/\mu\text{s}$	200 1.6	ns $\mu\text{C}$

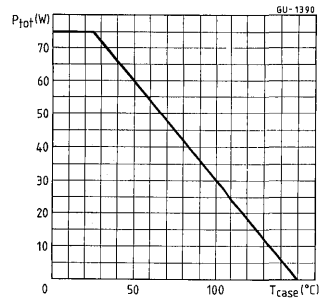
Safe operating areas



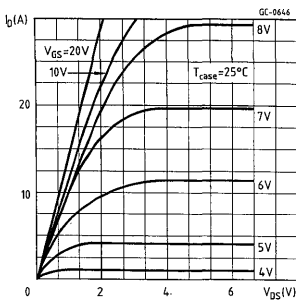
Thermal impedance



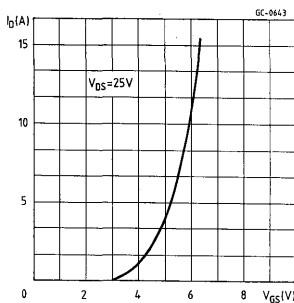
Derating curve



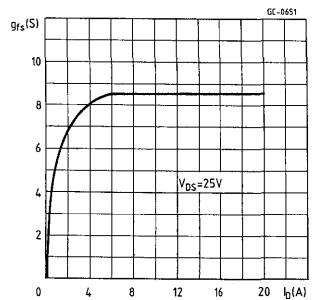
Output characteristics



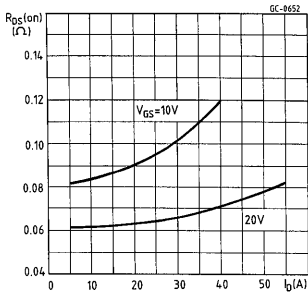
Transfer characteristics



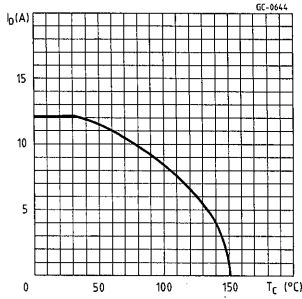
Transconductance



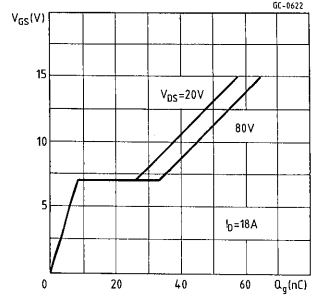
**Static drain-source on resistance**



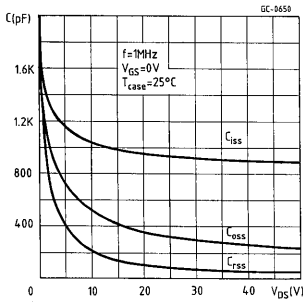
**Maximum drain current vs temperature**



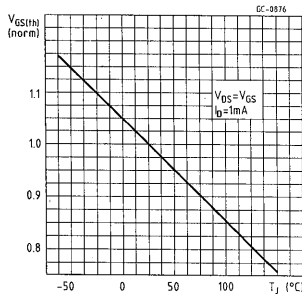
**Gate charge vs gate-source voltage**



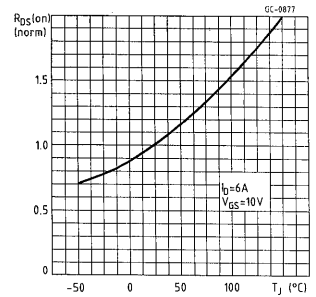
**Capacitance variation**



**Gate threshold voltage vs temperature**



**Drain-source on resistance vs temperature**



**Source-drain diode forward characteristics**

